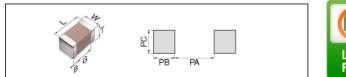
Creation Date : December 02, 2014

C3216X5R1E226M160AB (TDK item description : C3216X5R1E226MT****)

Applications Commercial Grade

Feature General (Up to 50V)

Series C3216 [EIA CC1206]







Size		
Length(L)	3.20mm +/-0.20mm	
Width(W)	1.60mm +/-0.20mm	
Thickness(T)	1.60mm +/-0.20mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	1.00mm Min.	
Recommended Land Pattern(PA)	2.10 to 2.50mm (Flow Soldering) 2.00 to 2.40mm (Flow Soldering)	Reflow Soldering)
Recommended Land Pattern(PB)	1.10 to 1.30mm (Flow Soldering) >1.00 to 1.20mm (Flow Soldering)	Reflow Soldering)
Recommended Land Pattern(PC)	1.00 to 1.30mm (Flow Soldering) 51.10 to 1.60mm (F	Reflow Soldering)
Recommended Slit Pattern(SD)		

Electrical Characteristics		
Capacitance	22uF +/-20%	
Rated Voltage	25Vdc	
Temperature Characteristic	X5R(+/-15%)	
Dissipation Factor	10% Max.	
Insulation Resistance	22MΩ Min.	

Other		
Soldering Method	Reflow, Flow	
AEC Q200	No	
Packing	Blister (Plastic)Taping [180mm Reel]	
Package Quantity	2000Pcs Min.	

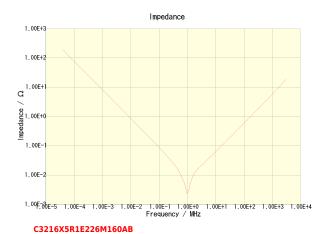
[•]This PDF document was created based on the data listed on the TDK Corporation website.

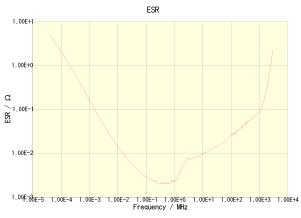
[•]All specifications are subject to change without notice.

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C3216X5R1E226M160AB

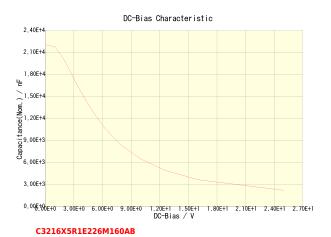
Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



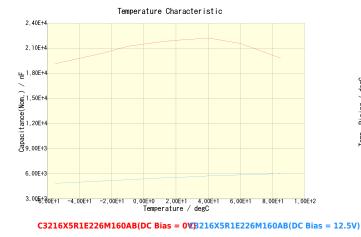


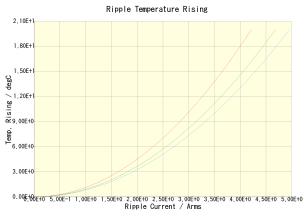












C3216X5R1E226M160AB(100kHz) C3216X5R1E226M160AB(500kHz)

C3216X5R1E226M160AB(1MHz)

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